



- NOTES:
- MATERIALS:
HOUSING: LCP, 30% GLASS FILLED, COLOUR: BLACK
CONTACT: TITANIUM COPPER TiCu
 - FINISH:
CONTACT AREA: 0.38 MICROMETER (15 MICRO-INCH) MIN. GOLD OVER 1.27 MICROMETER (50 MICRO-INCH) MIN NICKEL UNDERPLATE.
SMT TAIL AREA: 1.27 MICROMETER (50 MICRO-INCH MIN.) PURE TIN (MATTE) OVER 1.27 MICROMETER (50 MICRO-INCH) MIN. NICKEL UNDERPLATE.
OTHER AREA PLATING: 1.27 MICROMETER (50 MICRO-INCH) MIN NICKEL OVERALL
 - AT 1.63mm WORKING HEIGHT, FORCE IS 50g +25g/-10g AT LOADING CURVE
AT 1.75mm WORKING HEIGHT, FORCE IS 35g MIN AT LOADING CURVE
 - PRODUCT SPECIFICATION SEE TBA.
 - LAST DIGIT OF THE YEAR TO BE LOCATED.
 - DATE CODE TO BE LOCATED.

REVISED EC NO: S2014-0117 2013/07/31 DRINK: JAKH 2013/08/07 CHKD: JESSIECHUA 2013/08/07 APPR: SHONG 2013/08/07	DESCRIPTION	QUALITY SYMBOLS	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE NTS	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION	
		$F_A=0$	mm	INCH	DRAWN BY KJKOH	DATE 2013/05/22	TITLE 8 CIRCUITS COMPRESSION CONNECTOR			
		$F_E=0$	4 PLACES ± --- ± ---	3 PLACES ± --- ± ---	CHECKED BY JESSIECHUA	DATE 2013/08/07	MATERIAL NO. 78732-8021			
		$F_B=0$	2 PLACES ± 0.15 ± ---	1 PLACE ± 0.2 ± ---	APPROVED BY SHONG	DATE 2013/08/07	DOCUMENT NO. SD-78732-821			
A1	REV	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SIZE A3	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION					